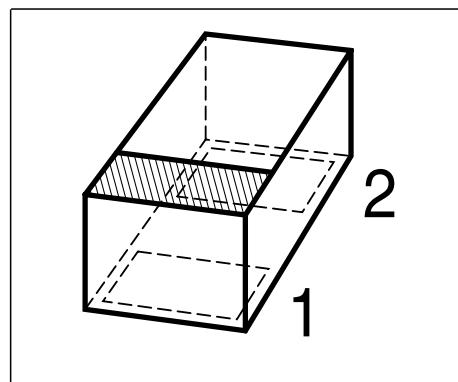


### Silicon PIN Diode

Preliminary data

- PIN diode for high speed switching of RF signals
- Very low forward resistance (low insertion loss)
- Very low capacitance (high isolation)
- small inductance
- For frequencies up to 3GHz
- Ultra small leadless package



Type	Marking	Pin Configuration			Package
BAR 63-02L	G	1 = C	2 = A	-	TSLP-2

### Maximum Ratings

Parameter	Symbol	Value	Unit
Diode reverse voltage	$V_R$	50	V
Forward current	$I_F$	100	mA
Total power dissipation	$P_{tot}$	tbd	mW
$T_S$ = tbd			
Operating temperature range	$T_{op}$	-55 ... 125	°C
Storage temperature	$T_{stg}$	-55 ... 150	

### Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - ambient <sup>1</sup> )	$R_{thJA}$	tbd	K/W
Junction - soldering point	$R_{thJS}$	tbd	

<sup>1</sup>Package mounted on alumina 15mm x 16.7mm x 0.7mm

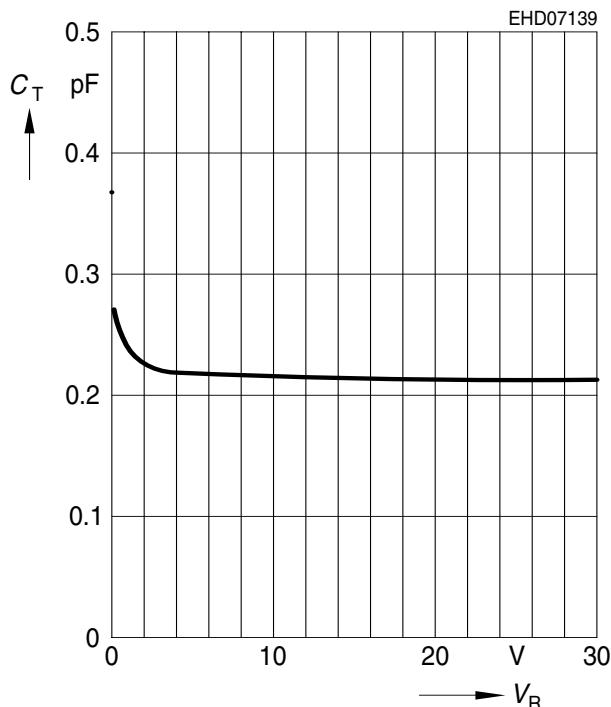
**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC Characteristics</b>					
Breakdown voltage $I_{(BR)} = 5 \mu\text{A}$	$V_{(\text{BR})}$	50	-	-	V
Reverse current $V_R = 35 \text{ V}$	$I_R$	-	-	10	nA
Forward voltage $I_F = 100 \text{ mA}$	$V_F$	-	0.95	1.2	V

Diode capacitance $V_R = 0 \text{ V}, f = 100 \text{ MHz}$ $V_R = 5 \text{ V}, f = 1 \text{ MHz}$	$C_T$	-	0.3	-	pF
-	-	0.21	0.3	-	
Forward resistance $I_F = 5 \text{ mA}, f = 100 \text{ MHz}$ $I_F = 10 \text{ mA}, f = 100 \text{ MHz}$	$r_f$	-	1.2	2	$\Omega$
-	-	1	-	-	
Charge carrier life time $I_F = 10 \text{ mA}, I_R = 6 \text{ mA}, I_R = 3 \text{ mA}$	$\tau_{rr}$	-	75	-	ns
Case capacitance $f = 1 \text{ MHz}$	$C_C$	-	0.05	-	pF
Series inductance	$L_S$	-	0.6	-	nH

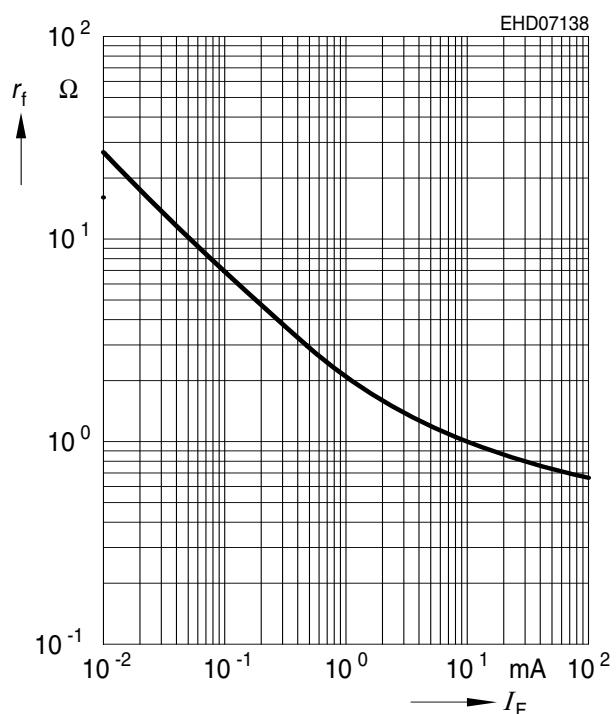
**Diode capacitance**  $C_T = f (V_R)$

$f = 1\text{MHz}$



**Forward resistance**  $r_f = f (I_F)$

$f = 100\text{MHz}$



**Forward current**  $I_F = f (V_F)$

$T_A = 25^\circ\text{C}$

